

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT5660628

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JOE F. WALCZYK	06/25/2019
JAMES HASTINGS	06/25/2019
MORTEN JENSEN	06/18/2019
TODD COONS	08/02/2019
RECEIVING PARTY DATA	
Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD.
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16417408
CORRESPONDENCE DATA	
Fax Number:	(971)244-4968
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	503-968-8233
Email:	dmontgomery@ghmip.com
Correspondent Name:	GREEN, HOWARD, & MUGHAL LLP.
Address Line 1:	5 CENTERPOINTE DRIVE
Address Line 2:	SUITE 400
Address Line 4:	LAKE OSWEGO, OREGON 97035
ATTORNEY DOCKET NUMBER:	01.AB5729-US
NAME OF SUBMITTER:	DANA M. MONTGOMERY
SIGNATURE:	/Dana M. Montgomery/
DATE SIGNED:	08/08/2019
Total Attachments: 8	
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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**Joe F. Walczyk
James Hastings
Morten Jensen
Todd Coons**

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Blvd. Santa Clara, CA. 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

**THERMAL SWITCH FOR RAPID THERMAL COUPLING AND
DECOUPLING OF DEVICES UNDER TEST**

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on May 20, 2019 as

United States Application Number 16/417,408 and

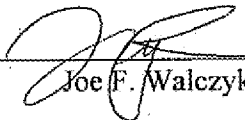
which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute

all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Joe F. Walczyk

6/25/19

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Date signed

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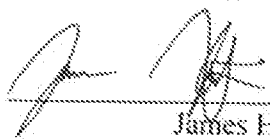
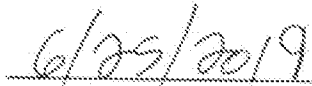
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..... Joe F. Walczyk Date signed
 James Hastings	 Date signed
..... Morten Jensen Date signed
..... Todd Coons Date signed

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Joe F. Walczyk

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Date signed

.....
James Hastings

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Date signed

Morten Jensen
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Morten Jensen

6-18-19
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Date signed

.....
Todd Coons

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Date signed

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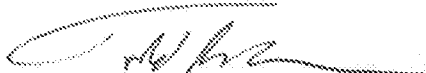
Date signed

James Hastings

Date signed

Morten Jensen

Date signed



Todd Coons

8/2/19
Date signed